ChemComm

Accepted Manuscript



This is an *Accepted Manuscript*, which has been through the Royal Society of Chemistry peer review process and has been accepted for publication.

Accepted Manuscripts are published online shortly after acceptance, before technical editing, formatting and proof reading. Using this free service, authors can make their results available to the community, in citable form, before we publish the edited article. We will replace this Accepted Manuscript with the edited and formatted Advance Article as soon as it is available.

You can find more information about *Accepted Manuscripts* in the **Information for Authors**.

Please note that technical editing may introduce minor changes to the text and/or graphics, which may alter content. The journal's standard <u>Terms & Conditions</u> and the <u>Ethical guidelines</u> still apply. In no event shall the Royal Society of Chemistry be held responsible for any errors or omissions in this *Accepted Manuscript* or any consequences arising from the use of any information it contains.



Journal Name

RSCPublishing

COMMUNICATION

The aerosol assisted chemical vapour deposition of SnSe and Cu₂SnSe₃ thin films from molecular precursors

Cite this: DOI: 10.1039/x0xx00000x

Punarja Kevin, ^a Sajid N. Malik, ^{a,b} Mohammad A. Malik ^a and Paul O'Brien ^a*

Received 00th January 2012, Accepted 00th January 2012

DOI: 10.1039/x0xx00000x

www.rsc.org/

Tin selenide (SnSe) and copper tin selenide (Cu₂SnSe₃) thin films have been deposited onto glass substrates by AACVD using [Sn(Ph₂PSe₂)₂] or a mixture with [Sn(Ph₂PSe₂)₂] and [Cu(acac)₂] respectively.

Tin selenide (SnSe) is a p-type semiconductor having a direct band gap of 0.9 eV and an indirect band gap of 1.3 eV. The material finds application in optoelectronic devices,¹ thermoelectric material and in lithium ion batteries.2 Various methods have been used for the deposition of SnSe thin films which include atmospheric pressure chemical vapour deposition (APCVD),3 pyrolysis,4 thermal evaporation5 and chemical bath deposition (CBD). Cu₂SnSe₃ is also a p-type semiconductor. In both cubic and wurtzitic forms of Cu₂SnSe₃ has a band gap close to 1.5 eV whereas the rhombohedral form has a direct band gap of 0.84 eV.7 Cu₂SnSe₃ has a high optical absorption co-efficient > 104.8 Its hole transport is chiefly controlled by the Cu-Se electro-conductive frame work.9 Cu₂SnSe₃ is based on earth abundant elements, has a simple crystal structure and phase diagram as compared to other quaternary chalcogenides. These features make Cu₂SnSe₃ an attractive candidate for variety of optoelectronic and solar energy applications. 10 The uses of Cu₂SnSe₃ are being explored in:: acousto-optic applications, 11 thermo-electronics, 12 and biomedical applications.

 Cu_2SnSe_3 nanocrystals have been synthesized by employing a variety of techniques including: a microwave assisted polyol method, ¹³ colloidal synthesis ¹⁴ and flash evaporation methods. ¹⁵ However, there are very few reports on the deposition of thin films. Kim *et al* have recently reported the growth of Cu_2SnSe_3

crystals on soda lime glass substrate by the co-evaporation method. ¹⁶ They studied the effect of substrate temperature on phase transformations between cubic and monoclinic phases and determined optical properties. The precise control of both the morphology and stoichiometry of Cu₂SnSe₃films remains a challenge. Chemical vapour deposition (CVD) is a promising technique for deposition of such films and can provide control over phase, morphology and microstructure. The utility of conventional CVD is limited by its dependence on volatile precursors. AACVD is a variant of CVD in which less or non-volatile precursors are flash evaporated. Sharma *et al.* have deposited SnSe thin films by AACVD at 490 °C and 530 °C using a diorganotin(IV)-2-pyridyl selenoate complex as single source precursor. ¹⁷

Previously, we have reported the synthesis and use of selenophosphinate complexes for binary, ternary and quaternary metal chalcogenide thin films by AACVD. 18,19 et.alreported the structure and the use (diphenyldiselenophosphinato)lead(II) complex as a precursor for PbSe nanoparticles.20 The deposition of CZTS thin films from diethyldithiocarbamato- complexes of Cu. Zn and Sn by AA-CVD has also been reported.21 Suitable mixtures of precursor materials with comparable thermal decomposition rate facilitate deposition and provide effective stoichiometric control especially in the deposition of more complex semiconductor materials.²¹ We have now synthesized a new complex bis(diphenylphosphinediselenoato)tin(II) [Sn(Ph2PSe2)2] and used it as a single source precursor for the deposition of tin selenide (SnSe) thin films by AACVD. We have also used it in combination with bis(2,4pentanedionato)copper(II) [Cu(acac)₂] for the deposition of Cu₂SnSe₃ thin films.

The preparation of $[Sn(Ph_2PSe_2)_2]$ complex was carried out in two steps. Potassium diphenylphosphinodiselenoate was reacted with diphenylphosphine, elemental selenium and potassium hydroxide as reported by Gusarova *et al.*²² The ligand

a The School of Chemistry and The School of Materials, The University of Manchester Oxford Road M13 9PL Manchester United Kingdom Tel.: +44-161-2751411; Fax: +44-161-2751411; E-mail: paul.obrien@manchester.ac.uk

b School of Chemical and Materials Engineering (SCME), National University of Sciences and Technology (NUST), Islamabad 44000 Pakistan.

ChemComm Page 2 of 5

was then reacted with $SnCl_2$ to give corresponding $[Sn(Ph_2PSe_2)_2]$ complex. The product was characterized by FTIR, NMR, mass spectrometry and elemental analysis. Thermogravimetric analysis of the complex showed decomposition between 350 °C and 400 °C to give a ~21% residue corresponding to SnSe (Figure S1, supplementary material).

COMMUNICATION

The deposition of SnSe by AACVD was carried out by using a 0.19 mmol solution of [Sn(Ph₂PSe₂)₂] in THF (15 mL). Deposition was carried out at 350 and 400 °C with an Ar flow rate of 180 sccm for 45 min. No deposition occurred at 350 °C whereas dark brown, well adhered films were obtained on glass substrates at 400 °C. Figure 1a shows p-XRD pattern of SnSe thin films deposited at 400 °C. The pattern is indexed to the standard ICDD pattern 00-048-1224 of orthorhombic SnSe with preferred orientation along (111) plane. SEM images (Figure 1b) show the uniform morphology of microcrystalline SnSe thin films. The morphology of the films is based on irregular sheets with an average size of ca 1.5 µm. Relative atomic percentage of Sn and Se atoms determined by EDX measurements was found to be 48:52 which is fairly close to the expected value of individual grains. The band gap of SnSe was found to be 1.1 eV (Figure S2, supplementary material) which is close to that reported previously for this material.1

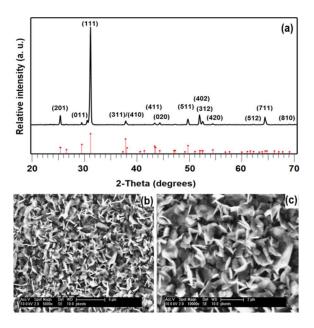


Figure 1. (a) p-XRD pattern of SnSe thin film deposited from $Sn[Ph_2PSe_2]_2$ precursor at 400 °C. Vertical lines below show standard ICDD pattern 00-048-1224 for orthorhombic SnSe (b) & (c) SEM images of as deposited thin film at 400 °C.

The deposition of Cu_2SnSe_3 was carried out by using a mixture of $[Cu(acac)_2]$ (0.38 mmol) and $[Sn(Ph_2PSe_2)_2]$ (0.19 mmol) in 15 mL THF at three different temperatures (350, 400 and 450 °C) for 1 hour. Deposition at 350 °C produced no thin films whereas those at 400 and 450 °C produced uniform, shiny dark brown films. The p-XRD patterns (Figure 2a) of the thin

films deposited at 400 °C and 450 °C correspond to the standard ICDD pattern 03-065-4145 for cubic Cu_2SnSe_3 phase with space group F-43m.

Journal Name

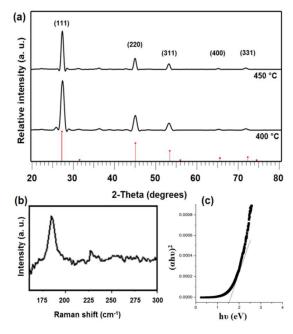


Figure 2. (a) p-XRD pattern of Cu_2SnSe_3 thin film deposited from $Sn[Ph_2PSe_2]_2$ and $Cu[acac]_2$ precursors at 400 and 450 °C indexed with standard ICDD pattern 03-065-4145 for cubic Cu_2SnSe_3 (b) Raman spectrum and (c) band gap plot for Cu_2SnSe_3 thin film deposited at 400 °C.

Films deposited at 400 °C had a uniform morphology (Fig. 3a) whereas two distinct types of crystallites were seen in those deposited at 450 °C. The films deposited at 400 °C consist of clusters of nanocrystalline flakes whilst the images of those deposited at 450 °C show larger semispherical crystallites thinly scattered in a background of irregularly shaped nanocrystallites. EDX analysis showed the chemical composition as Cu:Sn:Se 2.1:1.0:2.9 for thin films deposited at 400 °C and Cu:Sn:Se

1.9:1.0:2.6 for the films deposited at 450 °C. These results clearly show that the films deposited at 400 °C are of better quality being uniform in morphology and having better stoichiometry. The Raman spectrum of the thin films deposited at 400 °C is given in Figure 2(b) which shows a strong peak at ~180.6 cm $^{-1}$ with a minor peak at 232 cm $^{-1}$. These peaks correspond with the reported values (179.9 and 231.6 cm $^{-1}$) for A_1 and A_2 symmetry modes of $Cu_2SnSe_3.^{15}$ The absence of peaks at 150 and 260 cm $^{-1}$ for CuSe and SnSe shows the deposition of pure Cu_2SnSe_3 . Figure 2c shows the band gap of the films deposited at 400 °C as ~1.5 eV. This value is in agreement with that reported previously for $Cu_2SnSe_3.^{23-25}$

The deposited material was scratched from the films deposited at 400 °C and was further investigated by using transmission electron microscopy (TEM). TEM image (Figure 3c). The images show similar flake like crystals as observed in SEM. Selected area electron diffraction (SAED) pattern showed distinct rings suggesting the polycrystalline nature of the material (Figure 3d). Elemental mapping of a single particle as shown in

Journal Name COMMUNICATION

ChemComm

Figure 3e exhibited even distribution of Cu, Sn and Se in the crystal.

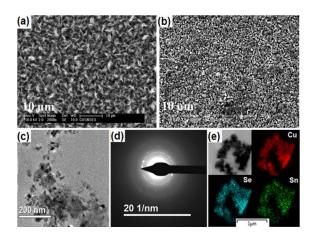


Figure 3. SEM images of Cu_2SnSe_3 thin films deposited at (a) 400 °C & (b) 500 °C. (c) TEM image (d) SAED pattern and (e) EDX elemental of a single Cu_2SnSe_3 particle

Conclusions

Page 3 of 5

A new complex, [Sn(Ph₂PSe₂)₂] has been synthesised and used as single source precursor in combination with [Cu(acac)₂] for the deposition of monophasic tin selenide (SnSe) and copper tin selenide (Cu₂SnSe₃) thin films onto glass substrates by AACVD at 400 °C and 450 °C. This is the first deposition of thin films of this material by AACVD which has potential applications in photovoltaics and optoelectronics.

Notes and references

Synthesis of Sn[Ph₂PSe₂]

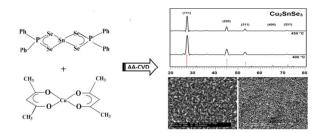
Ethanolic solution of KOH (1.5 mmol in 5 mL) and metallic Se powder ~ 100 mesh (0.158 g, 2.0 mmol) were added to ethanolic solution of diphenylphosphine (1.05 mmol in 6 mL EtOH) at room temperature under nitrogen. Vigorous stirring of the suspension was carried out at room temperature for ~ 5 minutes until all the Se dissolved. Colourless solution thus obtained was filtered and concentrated in rotary evaporator. The residue upon grinding in Et₂O (10 mL) gave potassium diphenylphosphinodiselenoate as white powder upon decanting the solvent and washing with Et2O. Methanolic solution of SnCl2 was added drop wise to a solution of 1.911 g (5 mmol) of potassium diphenylphosphinodiselenoate in 100 mL methanol. The precipitate formed was filtered, washed with hot methanol and dried. Yield (91 %). Elemental analysis calc. (%) for C₂₄H₂₀P₂Se₄: C 35.81, H 2.50, P 7.70, Sn 14.75; found: C 34.94, H 2.65, P 7.30, Sn 15.01; FTIR 3049 cm-1 (Ar-C-H), 685 cm-1 (P-C) and 539 cm-1 (P=Se); ¹H NMR (400 MHz, CDCL₃, Me₄Si) $\delta = 7.81$ ppm (dd, 8H, J 3.9, 7.1, 8.9, 4× o-Ph)., 7.44 ppm (m, 12H, 4×p-Ph and 4×m-Ph); 13C NMR δ = 127 ppm & 132 ppm (-Ph); APCI-MS: $[Ph_2PSe_2] + = m/Z 344.8$.

C. L. Zhang, H. H. Yin, M. Han, Z. H. Dai, H. Pang, Y. L. Zheng, Y.
Q. Lan, J. C. Bao and J. M. Zhu, ACS Nano, 2014, 8, 3761-3770.

- E. Schonherr and W. Stetter, J. Cryst. Growth, 1975, 30, 96-98; L.-D, Zhao, et al. Nature, 2014, 508, 373–377.
- 3 N. D. Boscher, C. J. Carmalt, R. G. Palgrave and I. P. Parkin, *Thin Solid Films*, 2008, 516, 4750-4757.
- P. Boudjouk, D. J. Seidler, S. R. Bahr and G. J. McCarthy, *Chem. Mater.*, 1994, 6, 2108-2112.
- 5 C. A. R. M. Sahayaraj, A. Mohan, V. Arivazhagan and S. Rajesh, Chalcogenide Lett, 2014, 11, 47-52; N. Sabli, Z. A. Talib, W. M. M. Yunus, Z. Zainal, H. S. Hilal and M. Fujii, Electrochemistry, 2014, 82, 25-30.
- 6 B. Pejova and I. Grozdanov, *Thin Solid Films*, 2007, **515**, 5203-5211.
- 7 J. Fan, W. Carrillo-Cabrera, L. Akselrud, I. Antonyshyn, L. D. Chen and Y. Grin, *Inorg Chem*, 2013, 52, 11067-11074.
- 8 Y. T. Zhai, S. Y. Chen, J. H. Yang, H. J. Xiang, X. G. Gong, A. Walsh, J. Kang and S. H. Wei, *Phys Rev B*, 2011, **84**; G. H. Chandra, O. L. Kumar, R. P. Rao and S. Uthanna, *J Mater Sci*, 2011, **46**, 6952-6959.
- G. Marcano, C. Rincon, L. M. de Chalbaud, D. B. Bracho and G. S. Perez, *J Appl Phys.*, 2001, 90, 1847-1853.
- 10 L. Zhu, Y. H. Qiang, Y. L. Zhao, X. Q. Gu, D. M. Song and C. B. Song, Acta Physico-Chimica Sinica, 2013, 29, 2339-2344; C. B. Song, Y. L. Zhao, D. M. Song, L. Zhu, X. Q. Gu and Y. H. Qiang, Intl. J. Electrochem. Sci., 2014, 9, 3158-3165.
- 11 G. Marcano, L. M. de Chalbaud, C. Rincon and G. S. Perez, *Mater Lett.*, 2002, **53**, 151-154.
- 12 M. Ibanez, D. Cadavid, U. Anselmi-Tamburini, R. Zamani, S. Gorsse, W. H. Li, A. M. Lopez, J. R. Morante, J. Arbiol and A. Cabot, *J Mater Chem A*, 2013, 1, 1421-1426.
- 13 H. Grisaru, V. G. Pol, A. Gedanken and I. Nowik, Eur J Inorg Chem., 2004, 1859-1864.
- 14 J. J. Wang, A. Singh, P. Liu, S. Singh, C. Coughlan, Y. N. Guo and K. M. Ryan, J. Am. Chem. Soc., 2013, 135, 7835-7838.
- 15 G. H. Chandra, O. L. Kumar, R. P. Rao and S. Uthanna, J. Mater Science, 2011, 46, 6952-6959.
- 16 K. M. Kim, H. Tampo, H. Shibata and S. Niki, *Materials Letters*, 2014, **116**, 61-63; K. M. Kim, H. Tampo, H. Shibata and S. Niki, *Thin Solid Films*, 2013, **536**, 111-114.
- 17 R. K. Sharma, G. Kedarnath, A. Wadawale, C. A. Betty, B. Vishwanadh and V. K. Jain, *Dalton Trans.*, 2012, 41, 12129.
- 18 C. Q. Nguyen, A. Adeogun, M. Afzaal, M. A. Malik and P. O'Brien, Chem Commun., 2006, 2179; C. Q. Nguyen, A. Adeogun, M. Afzaal, M. A. Malik and P. O'Brien, Chem Commun., 2006, 2182; C. Q. Nguyen, M. Afzaal, M. A. Malik, M. Helliwell, J. Raftery and P. O'Brien, J. Organometallic Chem., 2007, 692, 2669.
- 19 S. Mahboob, S. N. Malik, N. Haider, C. Q. Nguyen, M. A. Malik and P. O'Brien, J Cryst Growth, 2014, 394, 39-48.
- C. M. Evans, M. E. Evans, and T. D. Krauss, J. Am. Chem. Soc., 2010, 132, 10973-10975.
- 21 K. Ramasamy, M. A. Malik and P. O'Brien, *Chem. Sci.*, 2011, 2, 1170; K. Ramasamy, V. Kuznetsov, K. Gopal, M. A. Malik, J. Raftery, P. P. Edwards and P. O'Brien, *Chem. Mater.*, 2013, 25 (3), 266–276; K. Ramasamy, M. A. Malik, P. O'Brien, *Chem. Commun.*, 2012, 48, 5703-5714; D. J. Lewis, P.O'Brien, *Chem. Commun.*, 2014, 50, 6319.
- 22 A. V. Artem'ev, S. F. Malysheva, N. K. Gusarova and B. A. Trofimov, Synthesis, 2010, 2463–2467.22

Journal Name

- 23 J. J. Wang, A. Singh, P. Liu, S. Singh, C. Coughlan, Y. N. Guo and K. M. Ryan, *J Am Chem Soc*, 2013, **135**, 7835-7838.
- 24 S. J. Li and D. C. Pan, J Cryst Growth, 2012, 358, 38-42.
- 25 M. E. Norako, M. J. Greaney and R. L. Brutchey, *J Am Chem Soc*, 2011, **134**, 23-26.
- P. L. Musetha, N. Revaprasadu, M. A. Malik, P. O'Brien, MRS Proc., 2005, 879E, Z7.4.1.



Highlight: SnSe and Cu_2SnSe_3 thin films have been deposited onto glass substrates by AACVD from molecular precursors.